8-channel analog multiplexer/demultiplexer Rev. 11 — 11 September 2014

Product data sheet

#### 1. **General description**

The HEF4051B is an 8-channel analog multiplexer/demultiplexer with three address inputs (S1 to S3), an active LOW enable input (E), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). The device contains eight bidirectional analog switches, each with one side connected to an independent input/output (Y0 to Y7) and the other side connected to a common input/output (Z). With E LOW, one of the eight switches is selected (low-impedance ON-state) by S1 to S3. With E HIGH, all switches are in the high-impedance OFF-state, independent of S1 to S3. If break before make is needed, then it is necessary to use the enable input.

V<sub>DD</sub> and V<sub>SS</sub> are the supply voltage connections for the digital control inputs (S1 to S3, and E). The  $V_{DD}$  to  $V_{SS}$  range is 3 V to 15 V. The analog inputs/outputs (Y0 to Y7, and Z) can swing between  $V_{DD}$  as a positive limit and  $V_{EE}$  as a negative limit.  $V_{DD} - V_{EE}$  may not exceed 15 V. Unused inputs must be connected to V<sub>DD</sub>, V<sub>SS</sub>, or another input. For operation as a digital multiplexer/demultiplexer, V<sub>EE</sub> is connected to V<sub>SS</sub> (typically ground).  $V_{EE}$  and  $V_{SS}$  are the supply voltage connections for the switches.

#### 2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

#### **Applications** 3.

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating



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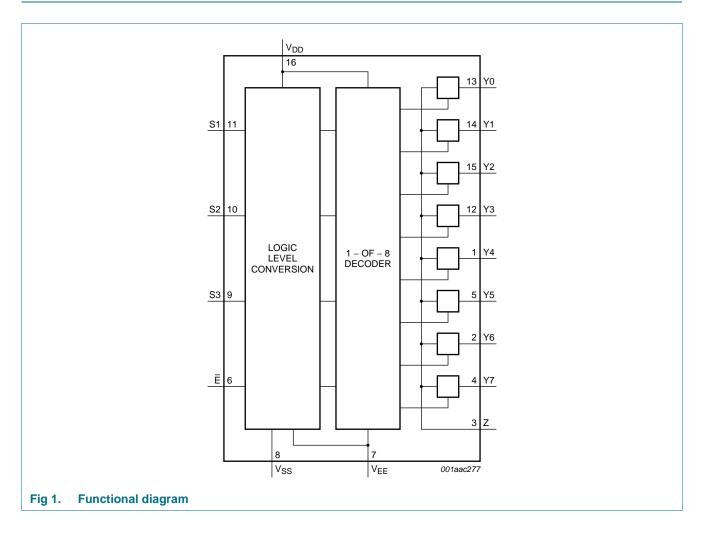
# 4. Ordering information

### Table 1. Ordering information

All types operate from −40 °C to +125 °C.

Type number	Package	Package									
	Name	Description	Version								
HEF4051BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4								
HEF4051BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1								
HEF4051BTS	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1								
HEF4051BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1								

# 5. Functional diagram

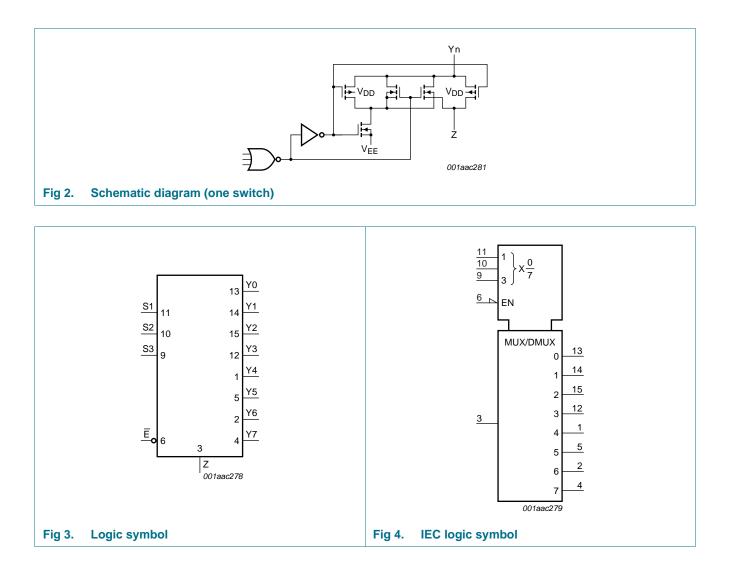


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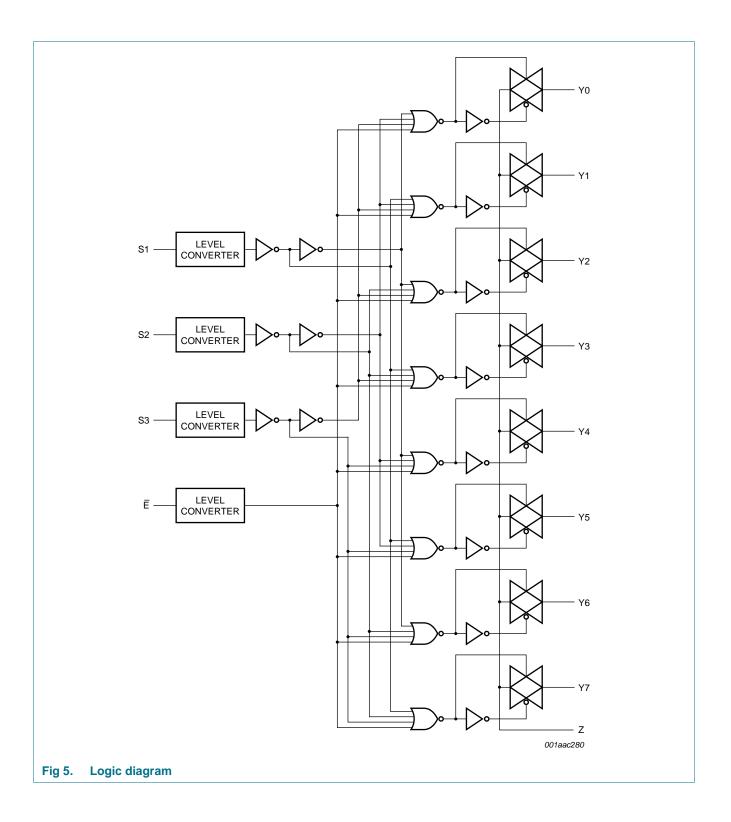
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# HEF4051B

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# 8-channel analog multiplexer/demultiplexer

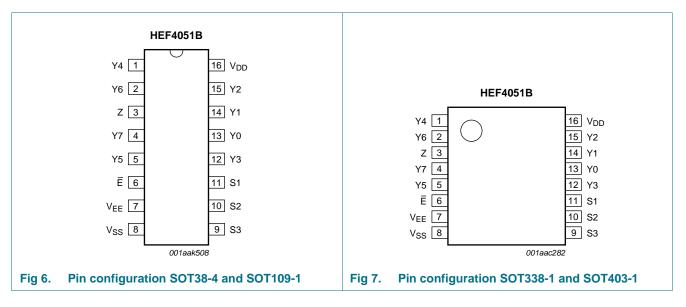


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# 6. Pinning information

# 6.1 Pinning



# 6.2 Pin description

## Table 2.Pin description

Symbol	Pin	Description
Ē	6	enable input (active LOW)
V <sub>EE</sub>	7	supply voltage
V <sub>SS</sub>	8	ground supply voltage
S1, S2, S3	11, 10, 9	select input
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	13, 14, 15, 12, 1, 5, 2, 4	independent input or output
Z	3	common output or input
V <sub>DD</sub>	16	supply voltage

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# 7. Functional description

## 7.1 Function table

Input				Channel ON
E	S3	S2	S1	
L	L	L	L	Y0 to Z
L	L	L	Н	Y1 to Z
L	L	Н	L	Y2 to Z
L	L	Н	Н	Y3 to Z
_	Н	L	L	Y4 to Z
_	Н	L	Н	Y5 to Z
_	Н	Н	L	Y6 to Z
_	Н	Н	Н	Y7 to Z
4	Х	Х	Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

# 8. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 V$  (ground).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DD</sub>	supply voltage			-0.5	+18	V
V <sub>EE</sub>	supply voltage	referenced to V <sub>DD</sub>	<u>[1]</u>	–18	+0.5	V
I <sub>IK</sub>	input clamping current	pins Sn and $\overline{E}$ ; V <sub>I</sub> < -0.5 V or V <sub>I</sub> > V <sub>DD</sub> + 0.5 V		-	±10	mA
VI	input voltage			-0.5	V <sub>DD</sub> + 0.5	V
I <sub>I/O</sub>	input/output current			-	±10	mA
I <sub>DD</sub>	supply current			-	50	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
T <sub>amb</sub>	ambient temperature			-40	+125	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2]			
		DIP16 package		-	750	mW
		SO16 package		-	500	mW
		SSOP16 package		-	500	mW
		TSSOP16 package		-	500	mW
Р	power dissipation	per output		-	100	mW

[1] To avoid drawing V<sub>DD</sub> current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V<sub>DD</sub> current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V<sub>DD</sub> or V<sub>EE</sub>.

For DIP16 package: P<sub>tot</sub> derates linearly with 12 mW/K above 70 °C.
 For SO16 package: P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.

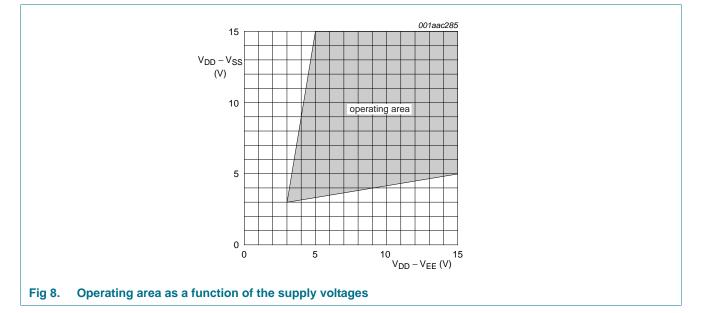
For SSOP16 and TSSOP16 packages:  $\mathrm{P}_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

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#### **Recommended operating conditions** 9.

Table 5. Recommended operating conditions										
Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
V <sub>DD</sub>	supply voltage	see Figure 8	3	-	15	V				
VI	input voltage		0	-	V <sub>DD</sub>	V				
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C				
Δt/ΔV	input transition rise and fall	$V_{DD} = 5 V$	-	-	3.75	μs/V				
	rate	V <sub>DD</sub> = 10 V	-	-	0.5	μs/V				
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V				



# 10. Static characteristics

#### Table 6. **Static characteristics**

 $V_{SS} = V_{EE} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>DD</sub>	' <sub>DD</sub>	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	25 °C	T <sub>amb</sub> =	85 °C	T <sub>amb</sub> = 125 °C		Unit
					Min	Max	Min	Max	Min	Мах	Min	Max	
V <sub>IH</sub>	HIGH-level input voltage		5 V		3.5	-	3.5	-	3.5	-	3.5	-	V
			10 V		7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V		11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level	but voltage	5 V		-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V		-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V		-	4.0	-	4.0	-	4.0	-	4.0	V
I	input leakage current		15 V		-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA

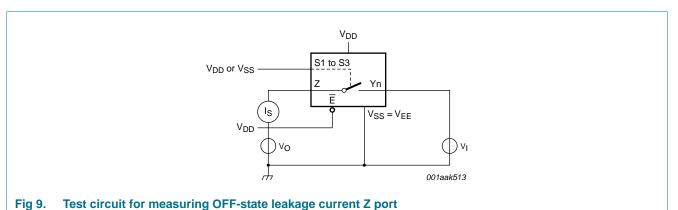
### 8-channel analog multiplexer/demultiplexer

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	= 25 °C	T <sub>amb</sub> =	= 85 °C	T <sub>amb</sub> =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
0(011)	OFF-state leakage current	Z port; all channels OFF; see <u>Figure 9</u>	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see <u>Figure 10</u>	15 V	-	-	-	200	-	-	-	-	nA
I <sub>DD</sub>	supply current	I <sub>O</sub> = 0 A	5 V	-	5	-	5	-	150	-	150	μA
			10 V	-	10	-	10	-	300	-	300	μΑ
			15 V	-	20	-	20	-	600	-	600	μA
CI	input capacitance	Sn, $\overline{E}$ inputs	-	-	-	-	7.5	-	-	-	-	pF

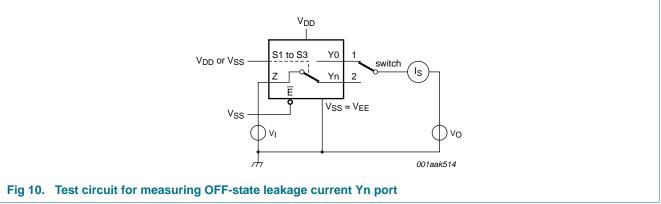
### Table 6. Static characteristics ...continued

 $V_{SS} = V_{EE} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

# 10.1 Test circuits







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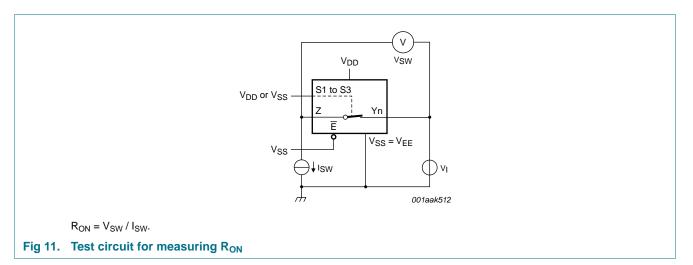
## 10.2 ON resistance

Table 7. ON resistance

 $T_{amb} = 25 \ ^{\circ}C; I_{SW} = 200 \ \mu A; V_{SS} = V_{EE} = 0 \ V.$ 

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Тур	Max	Unit
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = 0 V \text{ to } V_{DD} - V_{EE};$	5 V	350	2500	Ω
		see Figure 11 and Figure 12	10 V	80	245	Ω
			15 V	60	175	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	$V_I = 0 V$ ; see <u>Figure 11</u> and <u>Figure 12</u>	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_I = V_{DD} - V_{EE};$	5 V	120	365	Ω
		see Figure 11 and Figure 12	10 V	65	200	Ω
			15 V	50	155	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = 0 V \text{ to } V_{DD} - V_{EE}; \text{ see } Figure 11$	5 V	25	-	Ω
	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

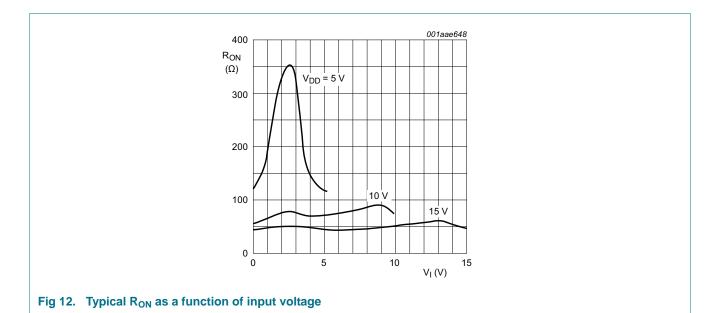
## 10.2.1 ON resistance waveform and test circuit



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# **11. Dynamic characteristics**

### Table 8. Dynamic characteristics

 $T_{amb} = 25 \ ^{\circ}C$ ;  $V_{SS} = V_{EE} = 0 \ V$ ; for test circuit see Figure 16.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW propagation delay	Yn, Z to Z, Yn; see Figure 13	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to Yn, Z; see Figure 14	5 V	150	300	ns
			10 V	60	120	ns
			15 V	45	90	ns
t <sub>PLH</sub>	LOW to HIGH propagation delay	Yn, Z to Z, Yn; see Figure 13	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to Yn, Z; see Figure 14	5 V	150	300	ns
			10 V	65	130	ns
			15 V	45	90	ns
t <sub>PHZ</sub>	HIGH to OFF-state	E to Yn, Z; see Figure 15	5 V	120	240	ns
	propagation delay		10 V	90	180	ns
			15 V	85	170	ns
t <sub>PZH</sub>	OFF-state to HIGH	E to Yn, Z; see Figure 15	5 V	140	280	ns
	propagation delay		10 V	55	110	ns
			15 V	40	80	ns
PLZ	LOW to OFF-state	E to Yn, Z; see Figure 15	5 V	145	290	ns
	propagation delay		10 V	120	240	ns
			15 V	115	230	ns

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$T_{amb} = 25 \text{ °C}; V_{SS} = V_{EE} = 0 \text{ V}; \text{ for test circuit see } Figure 16.$											
Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit					
OFF-state to LOW propagation delay		E to Yn, Z; see Figure 15	5 V	140	280	ns					
	propagation delay		10 V	55	110	ns					
			15 V	40	80	ns					

## Table 8. Dynamic characteristics ...continued

11.1 Waveforms and test circuit

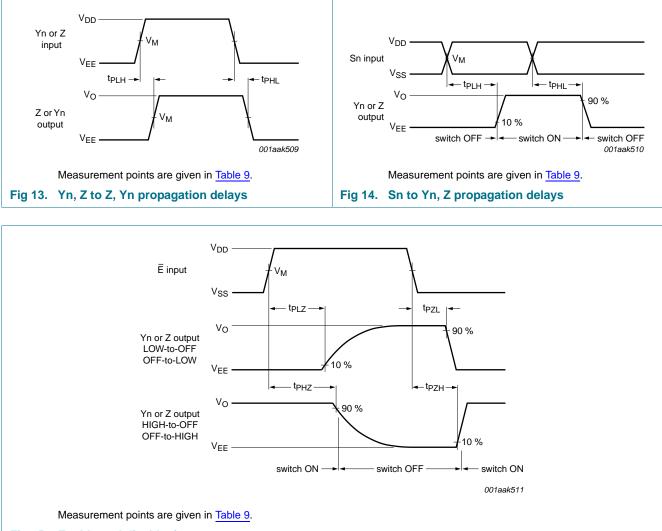
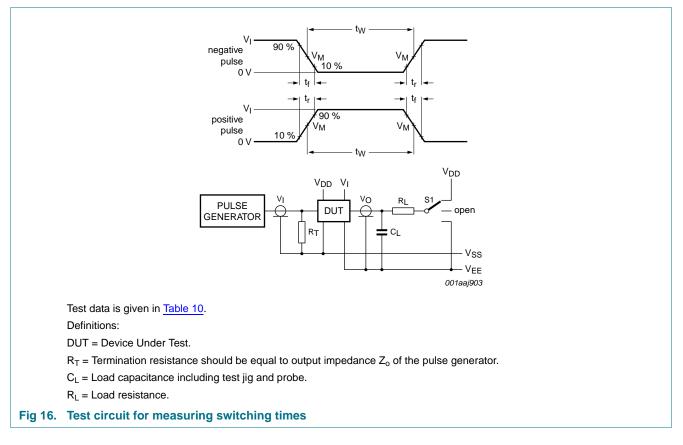


Fig 15. Enable and disable times

#### Table 9. Measurement points

Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>

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#### Table 10. Test data

Input				Load		S1 position				
Yn, Z	Sn and $\overline{E}$	t <sub>r</sub> , t <sub>f</sub>	V <sub>M</sub>	CL	RL	t <sub>PHL</sub> [1]	t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	other
$V_{\text{DD}}  \text{or}  V_{\text{EE}}$	$V_{\text{DD}} \text{ or } V_{\text{SS}}$	≤ 20 ns	0.5V <sub>DD</sub>	50 pF	10 kΩ	$V_{\text{DD}} \text{ or } V_{\text{EE}}$	V <sub>EE</sub>	V <sub>EE</sub>	V <sub>DD</sub>	V <sub>EE</sub>

[1] For Yn to Z or Z to Yn propagation delays use  $V_{EE}$ . For Sn to Yn or Z propagation delays use  $V_{DD}$ .

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## 11.2 Additional dynamic parameters

### Table 11. Additional dynamic characteristics

 $V_{\text{SS}} = V_{EE} = 0$  V;  $T_{amb} = 25$  °C.

Symbol	Parameter	Conditions	$V_{DD}$		Тур	Max	Unit
THD	total harmonic distortion	see Figure 17; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1 \text{ kHz}$	5 V	[1]	0.25	-	%
			10 V	<u>[1]</u>	0.04	-	%
			15 V	<u>[1]</u>	0.04	-	%
f <sub>(-3dB)</sub>	-3 dB frequency response	see Figure 18; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; channel ON; $V_I = 0.5V_{DD}$ (p-p)	5 V	<u>[1]</u>	13	-	MHz
			10 V	<u>[1]</u>	40	-	MHz
			15 V	<u>[1]</u>	70	-	MHz
$\alpha_{iso}$	isolation (OFF-state)	see Figure 19; $f_i = 1 \text{ MHz}$ ; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; channel OFF; $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	<u>[1]</u>	-50	-	dB
V <sub>ct</sub>	crosstalk voltage	digital inputs to switch; see Figure 20; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; E or Sn = V <sub>DD</sub> (square-wave)	10 V		50	-	mV
Xtalk	crosstalk	between switches; see Figure 21; $f_i = 1 \text{ MHz}; R_L = 1 \text{ k}\Omega;$ $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	[1]	-50	-	dB

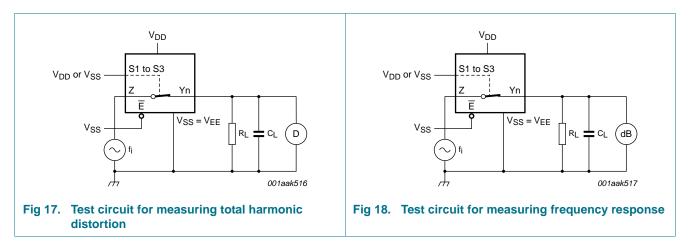
[1]  $f_i$  is biased at 0.5 V<sub>DD</sub>; V<sub>I</sub> = 0.5V<sub>DD</sub> (p-p).

## Table 12.Dynamic power dissipation PD

 $P_D$  can be calculated from the formulas shown;  $V_{EE} = V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

Symbol	Parameter	V <sub>DD</sub>	Typical formula for $P_D$ ( $\mu$ W)	where:
P <sub>D</sub> dynamic powe dissipation	dynamic power	5 V	$P_D = 1000 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$f_i = input frequency in MHz;$
	•	10 V	$P_D = 5500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f <sub>o</sub> = output frequency in MHz;
		15 V	$P_{D} = 15000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	C <sub>L</sub> = output load capacitance in pF;
				V <sub>DD</sub> = supply voltage in V;
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

## 11.2.1 Test circuits

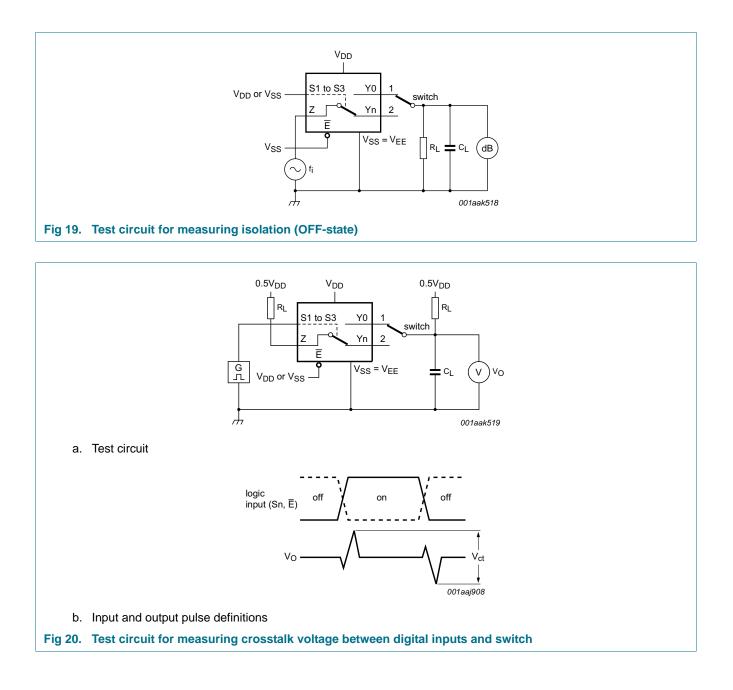


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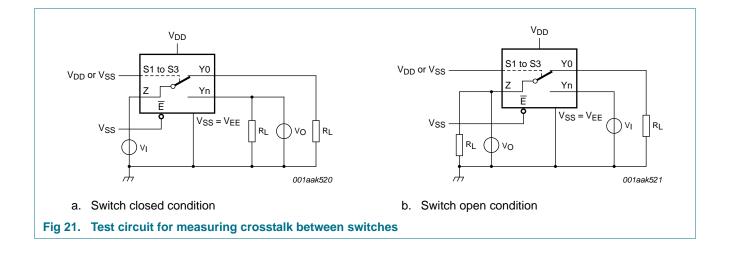
## 8-channel analog multiplexer/demultiplexer



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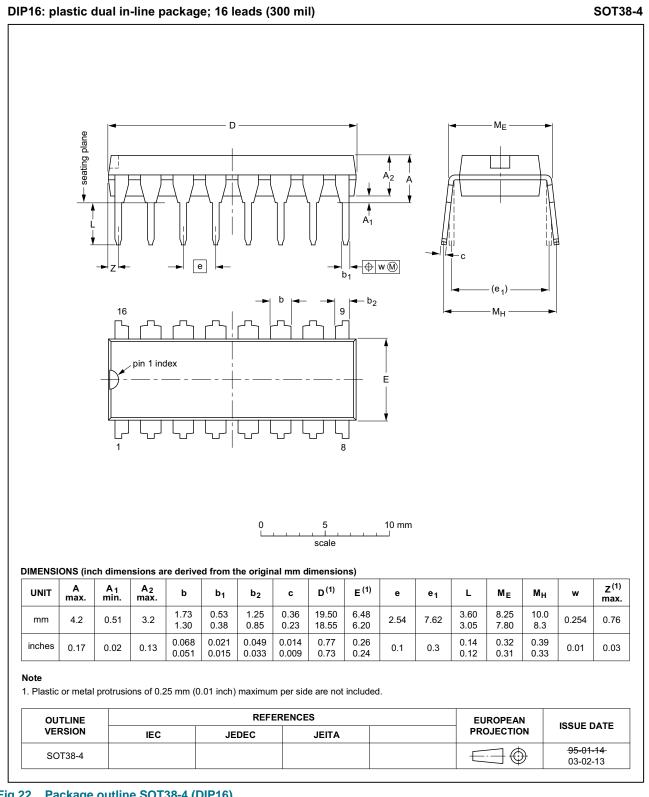
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# 8-channel analog multiplexer/demultiplexer



8-channel analog multiplexer/demultiplexer

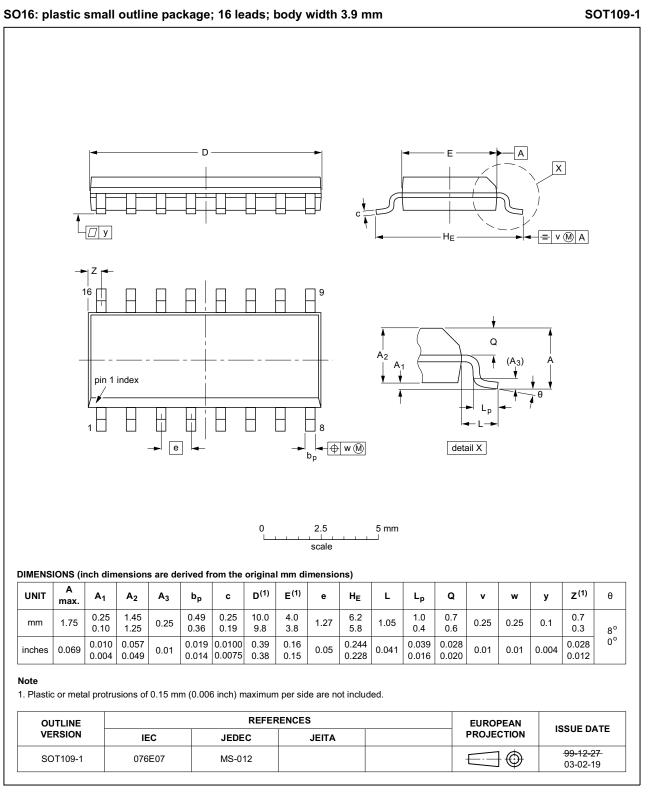
# 12. Package outline



## Fig 22. Package outline SOT38-4 (DIP16)

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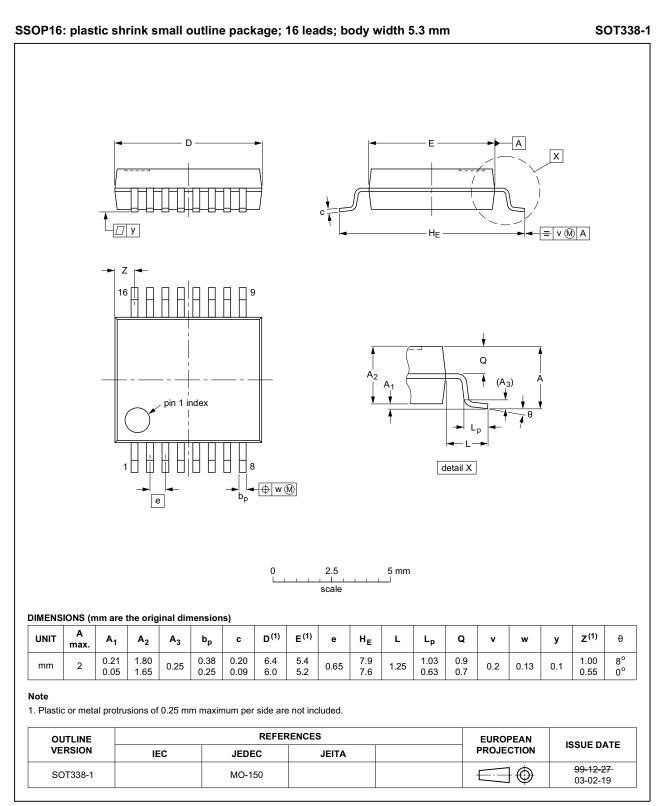
8-channel analog multiplexer/demultiplexer



#### Fig 23. Package outline SOT109-1 (SO16)

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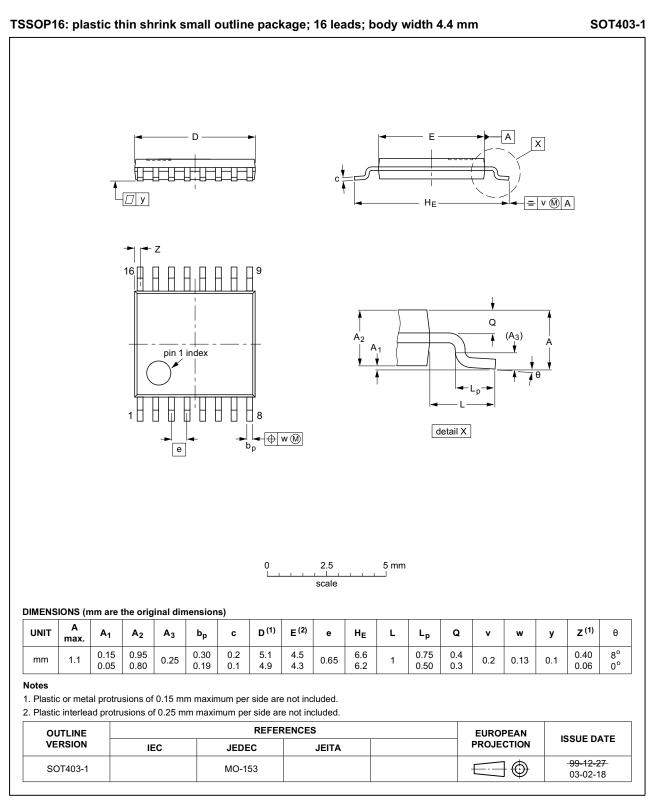
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### Fig 24. Package outline SOT338-1 (SSOP16)

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8-channel analog multiplexer/demultiplexer



## Fig 25. Package outline SOT403-1 (TSSOP16)

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## 8-channel analog multiplexer/demultiplexer

# **13. Abbreviations**

Table 13. Abbreviations			
Acronym	Description		
DUT	Device Under Test		

# 14. Revision history

### Table 14.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
HEF4051B v.11	20140911	Product data sheet	-	HEF4051B v.10		
Modifications:	• Figure 20: Te	est circuit modified				
HEF4051B v.10	20111117	Product data sheet	-	HEF4051B v.9		
Modifications:	Legal pages updated.					
	<ul> <li>Changes in "</li> </ul>	<ul> <li>Changes in "General description", "Features and benefits" and "Applications".</li> </ul>				
HEF4051B v.9	20100325	Product data sheet	-	HEF4051B v.8		
HEF4051B v.8	20100301	Product data sheet	-	HEF4051B v.7		
HEF4051B v.7	20091127	Product data sheet	-	HEF4051B v.6		
HEF4051B v.6	20090924	Product data sheet	-	HEF4051B v.5		
HEF4051B v.5	20090826	Product data sheet	-	HEF4051B v.4		
HEF4051B v.4	20050112	Product data sheet	-	HEF4051B_CNV v.3		
HEF4051B_CNV v.3	19950101	Product specification	-	HEF4051B_CNV v.2		
HEF4051B_CNV v.2	19950101	Product specification	-	-		

HEF4051B

### 8-channel analog multiplexer/demultiplexer

# **15. Legal information**

## 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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### 8-channel analog multiplexer/demultiplexer

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# 8-channel analog multiplexer/demultiplexer

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